

Bipolar Transistors Silicon NPN Epitaxial Type

TTC502

1. Applications

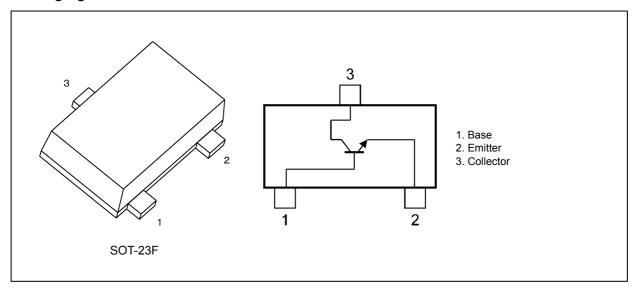
- · High-Speed Switching
- · DC-DC Converters

2. Features

- (1) AEC-Q101 qualified (Note 1)
- (2) High DC current gain: $h_{FE} = 120$ to 300 ($I_{C} = 0.1$ A)
- (3) Low collector-emitter saturation voltage: $V_{CE(sat)} = 0.14 \text{ V (max)}$
- (4) High-speed switching: $t_f = 200 \text{ ns (typ.)}$

Note 1: For detail information, please contact our sales.

3. Packaging and Internal Circuit



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4. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

Characteristics			Symbol	Rating	Unit
Collector-base voltage			V _{CBO}	180	V
Collector-emitter voltage			V _{CEO}	120	V
Emitter-base voltage			V _{EBO}	7	\ \
Collector current (DC)	,	(Note 1)	Ic	1.0	Α
Collector current (pulsed)	,	(Note 1)	I _{CP}	2.0	Α
Base current	,		I _B	100	mA
Collector power dissipation	DC	(Note 2)	Pc	1	W
Collector power dissipation	(t = 1 s)	(Note 2)	Pc	1.8	W
Junction temperature			Tj	150	℃
Storage temperature			T _{stg}	- 55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 1: Ensure that the channel temperature does not exceed 150 °C.
- Note 2: Device mounted on an FR4 board. (25.4 mm × 25.4 mm × 1.6 mm ,Cu pad: 645 mm²)



5. Electrical Characteristics

5.1. Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I _{CBO}	V _{CB} = 180 V , I _E = 0 mA	_	_	100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = 7 V, I _C = 0 mA	_	_	100	nA
Collector-base breakdown voltage	V _{(BR)CBO}	I _C = 1 mA, I _B = 0 mA	180	_	_	V
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C = 10 mA, I _B = 0 mA	120	_	_	V
DC current gain	h _{FE} (1)	V _{CE} = 2 V, I _C = 1 mA	100	_	_	_
	h _{FE} (2)	V _{CE} = 2 V, I _C = 0.1 A	120	_	300	
	h _{FE} (3)	V _{CE} = 2 V, I _C = 0.3 A	60	_	_	
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 0.3 A, I _B = 10 mA	_	_	0.14	V
Base-emitter saturation voltage	V _{BE(sat)}	I _C = 0.3 A, I _B = 10 mA	_	_	1.10	V

5.2. Dynamic Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Switching time (rise time)	t _r	See Figure 5.2.1 $V_{cc} \approx 72 \text{ V}, R_L = 240 \Omega,$ $I_{B1} = 10 \text{ mA}, I_{B2} = 10 \text{ mA}$	_	100		ns
Switching time (storage time)	t _{stg}		_	1500		ns
Switching time (fall time)	t _f		_	200	_	ns

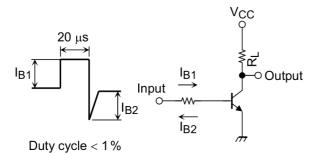


Fig. 5.2.1 Switching Time Test Circuit

6. Marking

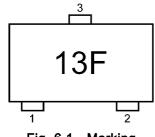


Fig. 6.1 Marking



7. Characteristics Curves (Note)

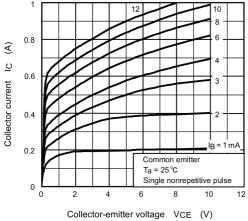


Fig. 7.1 I_C - V_{CE}

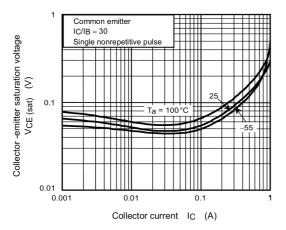
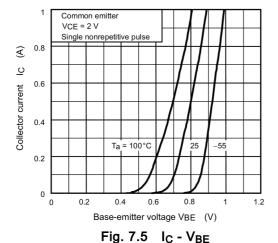


Fig. 7.3 V_{CE(sat)} - I_C



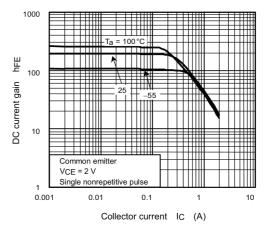


Fig. 7.2 hFE - IC

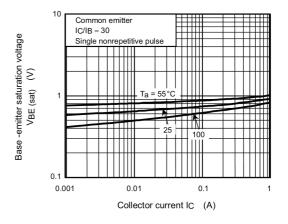


Fig. 7.4 V_{BE(sat)} - I_C



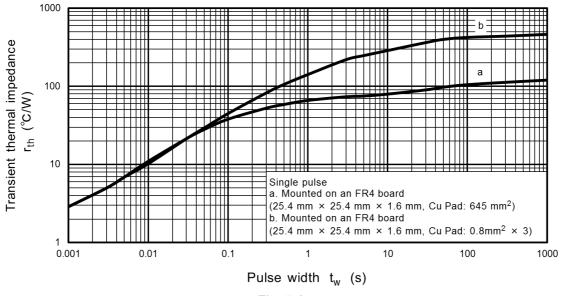


Fig. 7.6 rth - tw

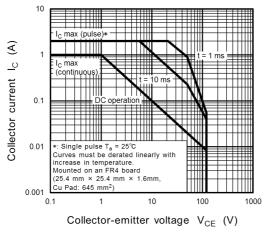


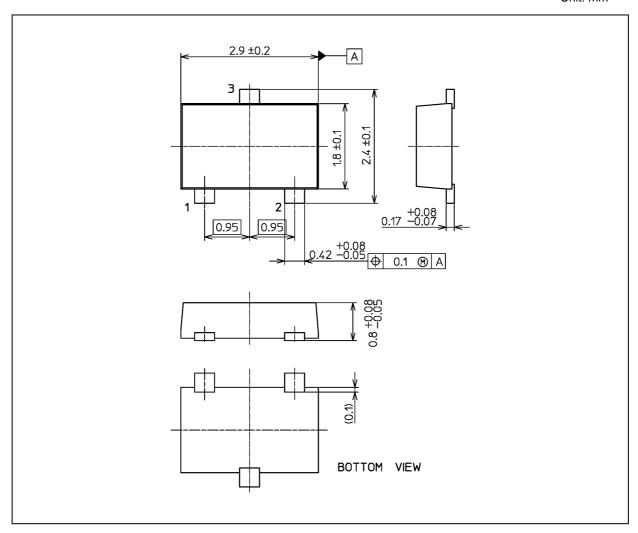
Fig. 7.7 Safe Operating Area

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.011 g (typ.)

	Package Name(s)
Nickname: SOT-23F	



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